

2SD1119

Silicon NPN epitaxial planar type

For low-frequency power amplification

■ Features

- Low collector-emitter saturation voltage $V_{CE(sat)}$
- Satisfactory operation performances at high efficiency with the low-voltage power supply.
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	40	V
Collector-emitter voltage (Base open)	V_{CEO}	25	V
Emitter-base voltage (Collector open)	V_{EBO}	7	V
Collector current	I_C	3	A
Peak collector current	I_{CP}	5	A
Collector power dissipation *	P_C	1	W
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note) *: Printed circuit board: Copper foil area of 1 cm^2 or more, and the board thickness of 1.7 mm for the collector portion

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

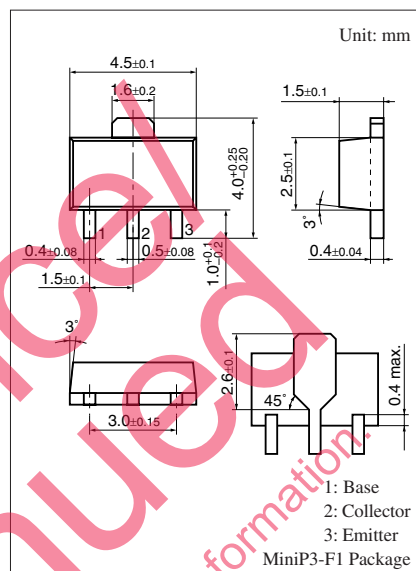
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = 1\text{ mA}, I_B = 0$	25			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = 10\ \mu\text{A}, I_C = 0$	7			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 10\text{ V}, I_E = 0$			0.1	μA
Forward current transfer ratio *1	h_{FE1} *2	$V_{CE} = 2\text{ V}, I_C = 0.5\text{ A}$	230		600	—
	h_{FE2}	$V_{CE} = 2\text{ V}, I_C = 2\text{ A}$	150			
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_C = 3\text{ A}, I_B = 0.1\text{ A}$			1	V
Transition frequency	f_T	$V_{CB} = 6\text{ V}, I_E = -50\text{ mA}, f = 200\text{ MHz}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = 20\text{ V}, I_E = 0, f = 1\text{ MHz}$			50	pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

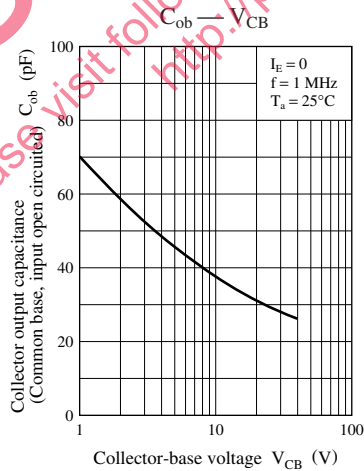
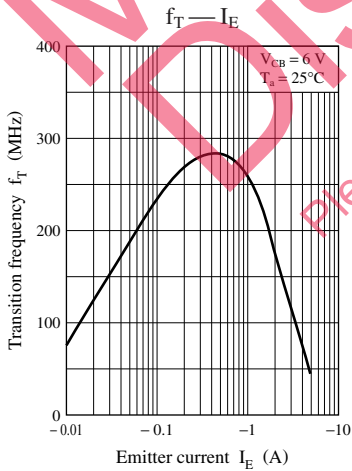
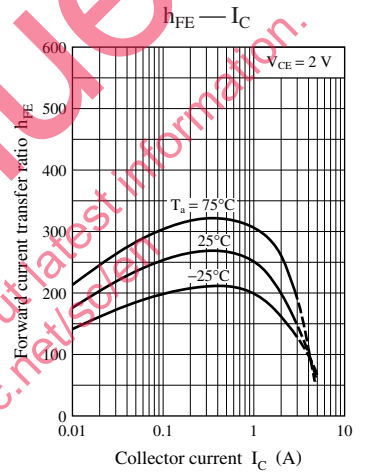
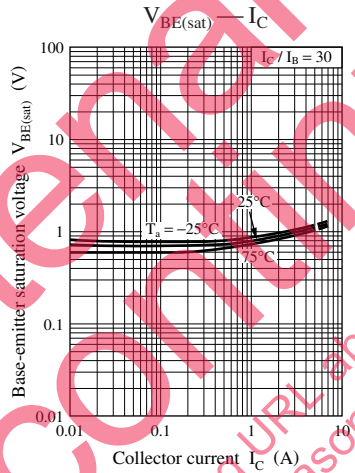
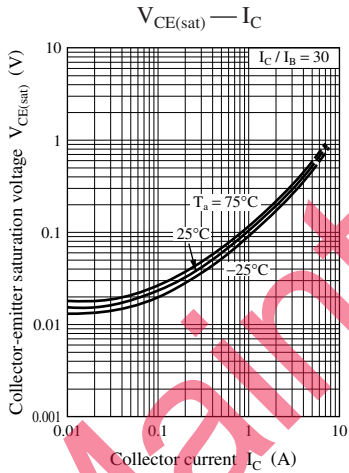
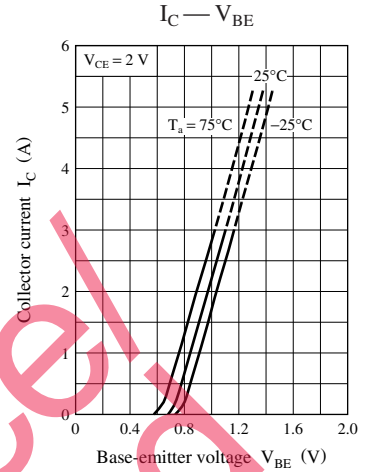
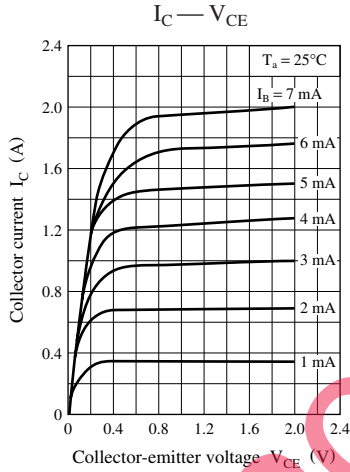
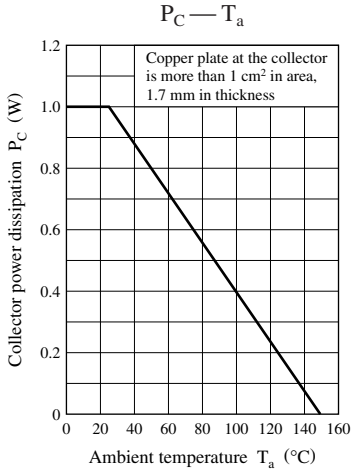
2. *1: Pulse measurement

*2: Rank classification

Rank	Q	R
h_{FE1}	230 to 380	340 to 600



Marking Symbol: T



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